

Clean Version of Claims

1. A single use processing substrate, comprising;
A.1. a first cut-resistant layer having a first surface area and including a tissue ply and a thermoplastic material ply; and
a second layer having a second surface area and including a tissue ply and a thermoplastic material ply, wherein the first layer is secured to the second layer such that a portion of the second surface area is laterally disposed outside of the first surface area.

--64. The single use processing substrate of claim 30, wherein the adhesive is applied in interrupted patterns.

A.2
65. The single use processing substrate of claim 64, wherein the adhesive is applied as a series of spaced spots.

66. The single use processing substrate of claim 30, wherein the adhesive is applied in a continuous pattern.

67. The single use processing substrate of claim 61, wherein the adhesive is applied in interrupted patterns.

68. The single use processing substrate of claim 67, wherein the adhesive is applied as a series of spaced spots.

69. The single use processing substrate of claim 61, wherein the adhesive is applied in a continuous pattern.--